

January 2014

# PN2907A / MMBT2907A / PZT2907A 60 V PNP General-Purpose Transistor

#### **Features**

- High DC Current Gain (hFE) Range: 100 ~ 300
- High-Current Gain Bandwidth Product (f<sub>T</sub>):
   200 MHz (Minimum)
- Maximum Turn-On Time (ton): 45 ns
- Maximum Turn-Off Time (t<sub>off</sub>): 100 ns
- Ultra-Small Surface-Mount Package: SOT-223 (PZT2907A)

#### Description

The PN2907A, MMBT2907A, and PZT2907A are 60 V PNP bipolar transistors designed for use as a general-purpose amplifier or switch in applications that require up to 500 mA. Offered in an ultra-small surface-mount package (SOT-223), the PZT2907A is ideal for space-constrained systems. The NPN complementary types are the PN2222A, MMBT2222A, and PZT2222A; respectively.

## **Applications**

- · General-Purpose Amplifier
- Switch



# **Ordering Information**

Part Number	Top Mark	Package	Packing Method
PN2907ABU	2907A	TO-92 3L	Bulk
PN2907ATF	2907A	TO-92 3L	Tape and Reel
PN2907ATFR	2907A	TO-92 3L	Tape and Reel
PN2907ATA	2907A	TO-92 3L	Ammo
PN2907ATAR	2907A	TO-92 3L	Ammo
MMBT2907A	2F	SOT-23 3L	Tape and Reel
MMBT2907A_D87Z	2F	SOT-23 3L	Tape and Reel
PZT2907A	2907A	SOT-223 4L	Tape and Reel

## **Absolute Maximum Ratings**(1),(2)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Value	Unit
V <sub>CEO</sub>	Collector-Emitter Voltage	-60	V
V <sub>CBO</sub>	Collector-Base Voltage	-60	V
$V_{EBO}$	Emitter-Base Voltage	-5.0	V
I <sub>C</sub>	Collector Current - Continuous	-800	mA
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

#### Notes:

- 1. These ratings are based on a maximum junction temperature of 150°C.
- 2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty cycle operations.

#### **Thermal Characteristics**

Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Max.			Unit
	i arameter	PN2907A <sup>(4)</sup>	MMBT2907A <sup>(3)</sup>	PZT2907A <sup>(4)</sup>	Oilit
D	Total Device Dissipation	625	350	1000	mW
$P_{D}$	Derate Above 25°C	5.0	2.8	8.0	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3			°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	125	°C/W

#### Notes:

- 3. Device is mounted on FR-4 PCB 1.6 inch X 1.6 inch X 0.06 inch.
- 4. PCB size: FR-4 76 x 114 x 1.57 mm<sup>3</sup> (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

### **Electrical Characteristics**

Values are at  $T_A = 25^{\circ}C$  unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit	
Off Charac	cteristics			•		
V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage <sup>(5)</sup>	$I_C = -10 \text{ mA}, I_B = 0$	-60		V	
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_C = -10 \mu A, I_E = 0$	-60		V	
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = -10 \mu A, I_C = 0$	-5.0		V	
I <sub>BL</sub>	Base Cut-Off Current	V <sub>CE</sub> = -30 V, V <sub>EB</sub> = -0.5 V		-50	nA	
I <sub>CEX</sub>	Collector Cut-Off Current	V <sub>CE</sub> = -30 V, V <sub>EB</sub> = -0.5 V		-50	nA	
I <sub>CBO</sub>	Collector Cut-Off Current	V <sub>CB</sub> = -50 V, I <sub>E</sub> = 0		-0.02		
		V <sub>CB</sub> = -50 V, I <sub>E</sub> = 0, T <sub>A</sub> = 150°C		-20	- μΑ	
On Charac	teristics				I	
		$I_C = -0.1 \text{ mA}, V_{CE} = -10 \text{ V}$	75			
		I <sub>C</sub> = -1.0 mA, V <sub>CE</sub> = -10 V	100			
h <sub>FE</sub>	DC Current Gain	I <sub>C</sub> = -10 mA, V <sub>CE</sub> = -10 V	100			
		I <sub>C</sub> = -150 mA, V <sub>CE</sub> = -10 V <sup>(5)</sup>	100	300		
		I <sub>C</sub> = -500 mA, V <sub>CE</sub> = -10 V <sup>(5)</sup>	50			
	Collector-Emitter Saturation Voltage <sup>(5)</sup>	I <sub>C</sub> = -150 mA, I <sub>B</sub> = -15 mA		-0.4	V	
V <sub>CE</sub> (sat)		I <sub>C</sub> = -500 mA, I <sub>B</sub> = -50 mA		-1.6		
\/ (aat)	B	$I_C = -150 \text{ mA}, I_B = -15 \text{ mA}^{(5)}$		-1.3	V	
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	$I_C = -500 \text{ mA}, I_B = -50 \text{ mA}$		-2.6		
Small Sigr	nal Characteristics			•		
f <sub>T</sub>	Current Gain - Bandwidth Product	I <sub>C</sub> = -50 mA, V <sub>CE</sub> = -20 V, f = 100 MHz	200		MHz	
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> = -10 V, I <sub>E</sub> = 0, f = 100 kHz		8.0	pF	
C <sub>ib</sub>	Input Capacitance	$V_{EB} = -2.0 \text{ V}, I_{C} = 0, f = 100 \text{ kHz}$		30	pF	
Switching	Characteristics	<u> </u>		•		
t <sub>on</sub>	Turn-On Time	$V_{CC}$ = -30 V, $I_{C}$ = -150 mA, $I_{B1}$ = -15 mA		45	ns	
t <sub>d</sub>	Delay Time			10	ns	
t <sub>r</sub>	Rise Time			40	ns	
t <sub>off</sub>	Turn-Off Time	$V_{CC}$ = -6.0 V, $I_{C}$ = -150 mA, $I_{B1}$ = $I_{B2}$ = -15mA		100	ns	
t <sub>s</sub>	Storage Time			80	ns	
t <sub>f</sub>	Fall Time			30	ns	

#### Notes:

5. Pulse test: pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2.0%.

# **Typical Performance Characteristics**

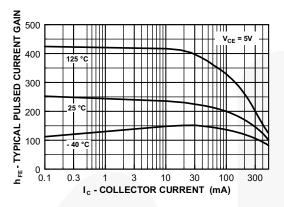


Figure 1. Typical Pulsed Current Gain vs. Collector Current

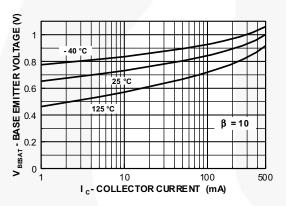


Figure 3. Base-Emitter Saturation Voltage vs. Collector Current

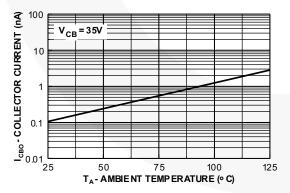


Figure 5. Collector Cut-Off Current vs.
Ambient Temperature

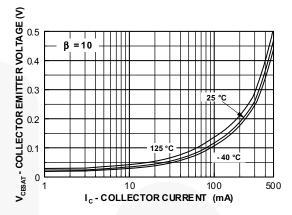


Figure 2. Collector-Emitter Saturation Voltage vs. Collector Current

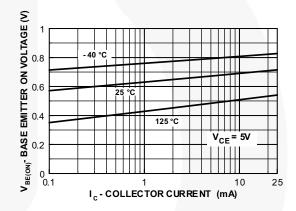


Figure 4. Base-Emitter On Voltage vs. Collector Current

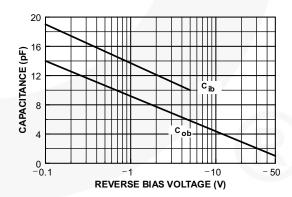


Figure 6. Input and Output Capacitance vs. Reverse Bias Voltage

# **Typical Performance Characteristics** (Continued)

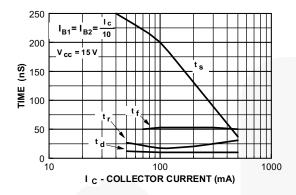


Figure 7. Switching Times vs. Collector Current

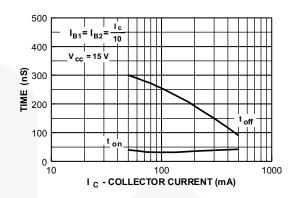


Figure 8. Turn-On and Turn-Off Times vs. Collector Current

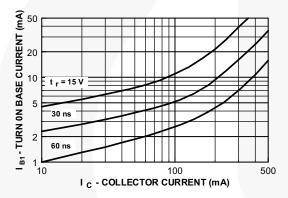


Figure 9. Rise Time vs. Collector and Turn-On Base Currents

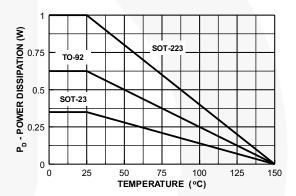


Figure 10. Power Dissipation vs. Ambient Temperature

# **Typical Performance Characteristics** (f = 1.0 kHz)

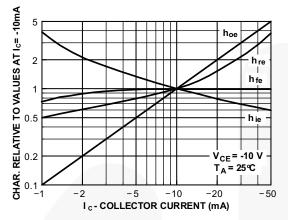
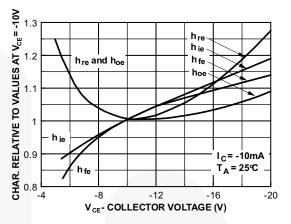


Figure 11. Common Emitter Characteristics



**Figure 12. Common Emitter Characteristics** 

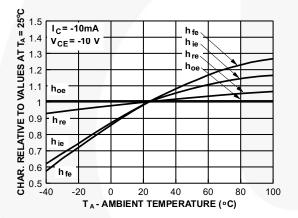


Figure 13. Common Emitter Characteristics

## **Physical Dimensions**

# **TO-92 (Bulk)**

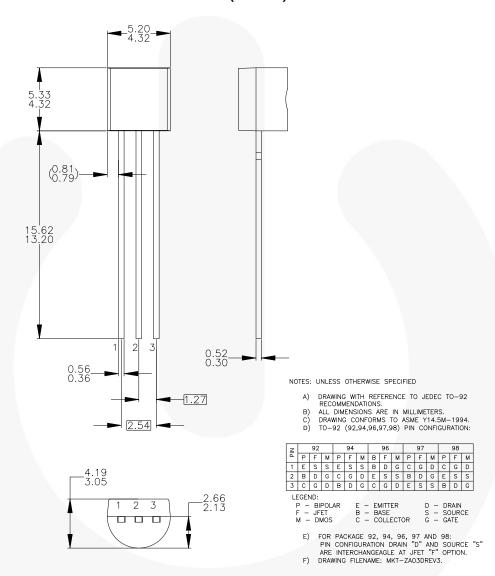


Figure 14. 3-LEAD, TO92, JEDEC TO-92 COMPLIANT STRAIGHT LEAD CONFIGURATION (OLD TO92AM3) (ACTIVE)

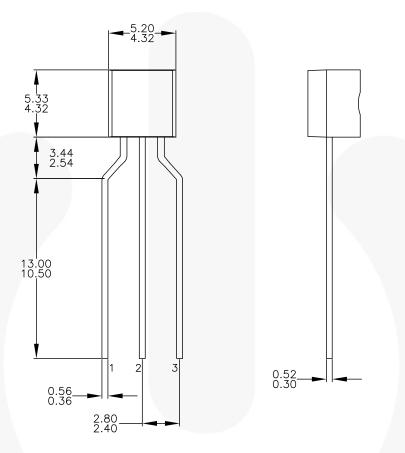
Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

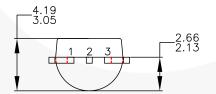
Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: <a href="http://www.fairchildsemi.com/dwg/ZA/ZA03D.pdf">http://www.fairchildsemi.com/dwg/ZA/ZA03D.pdf</a>.

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: <a href="http://www.fairchildsemi.com/packing\_dwg/PKG-ZA03D\_BK.pdf">http://www.fairchildsemi.com/packing\_dwg/PKG-ZA03D\_BK.pdf</a>.

## Physical Dimensions (Continued)

# TO-92 (Tape and Reel, Ammo)





NOTES: UNLESS OTHERWISE SPECIFIED

- DRAWING CONFORMS TO JEDEC MS-013, VARIATION AC.
  ALL DIMENSIONS ARE IN MILLIMETERS.
  DRAWING CONFORMS TO ASME Y14.5M-2009.
  DRAWING FILENAME: MKT-ZAO3FREV3.
  FAIRCHILD SEMICONDUCTOR.

Figure 15. 3-LEAD, TO92, MOLDED 0.200 IN LINE SPACING LEAD FORM (J61Z OPTION) (ACTIVE)

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/dwq/ZA/ZA03F.pdf.

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: http://www.fairchildsemi.com/packing\_dwg/PKG-ZA03F\_BK.pdf.

## Physical Dimensions (Continued)

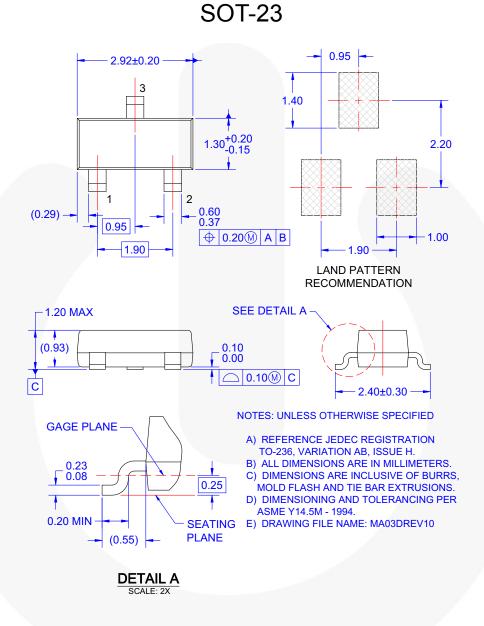


Figure 16. 3-LEAD, SOT23, JEDEC TO-236, LOW PROFILE (ACTIVE)

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: <a href="http://www.fairchildsemi.com/dwg/MA/MA03D.pdf">http://www.fairchildsemi.com/dwg/MA/MA03D.pdf</a>.

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: <a href="http://www.fairchildsemi.com/packing\_dwg/PKG-MA03D.pdf">http://www.fairchildsemi.com/packing\_dwg/PKG-MA03D.pdf</a>.

### Physical Dimensions (Continued)

# **SOT-223**

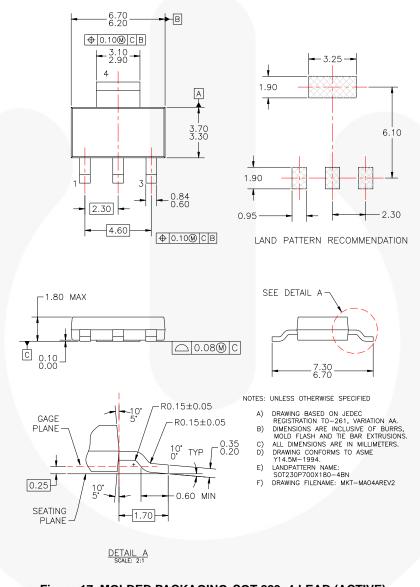


Figure 17. MOLDED PACKAGING, SOT-223, 4-LEAD (ACTIVE)

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/dwg/MA/MA04A.pdf.

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: <a href="http://www.fairchildsemi.com/packing-dwg/PKG-MA04A">http://www.fairchildsemi.com/packing-dwg/PKG-MA04A</a> BK.pdf.





#### **TRADEMARKS**

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™ F-PFS™ AX-CAP®, **FRFET®** Global Power Resource<sup>SM</sup> BitSiC™ Build it Now™ GreenBridge™ CorePLUS™ Green FPS™ CorePOWER™ Green FPS™ e-Series™ Gmax™  $CROSSVOLT^{\text{\tiny TM}}$ GTO™  $\mathsf{CTL}^{\mathsf{TM}}$ Current Transfer Logic™ IntelliMAX™

DEUXPEED® ISOPLANAR™

Dual Cool™ Making Small Speakers Sound Louder

EcoSPARK® and Better™

EfficientMax™ MegaBuck™

ESBC™ MICROCOUPLER™

MicroFET™

Tairchild® MicroPak™ MicroPak™
Fairchild Semiconductor® MillerDrive™
FACT Quiet Series™ MotionMax™
FACT® mWSaver®
FAST® OptoHiT™

FAST® mWSaver®
FastvCore™ OptoHiT™ OPTOLOGIC®
FETBench™ OPTOPLANAR®
FPS™

PowerTrench<sup>®</sup> PowerXS™

Programmable Active Droop™

QFET<sup>®</sup>
QS<sup>™</sup>
Quiet Series<sup>™</sup>
RapidConfigure<sup>™</sup>

Saving our world, 1mW/W/kW at a time™ SignalWise™

SmartMax<sup>™</sup> SMART START<sup>™</sup>

Solutions for Your Success™

SPM®
STEALTH™
SuperFET®
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8
SupreMOS®
SyncFET™

Sync-Lock<sup>TM</sup>
SYSTEM
GENERAL®\*
TinyBoost®
TinyBuck®
TinyCalc<sup>TM</sup>
TinyLogic®
TINYOPTO<sup>TM</sup>
TinyPower<sup>TM</sup>
TinyPWMT<sup>TM</sup>
TranSiC<sup>TM</sup>
Trault Detect<sup>TM</sup>
TRUECURRENT®\*

µSerDes<sup>TM</sup>

SerDes"
UHC®
UItra FRFET™
UniFET™
VCX™
VisualMax™
VoltagePlus™
XS™

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN, NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### PRODUCT STATUS DEFINITIONS

#### **Definition of Terms**

Definition of Terms			
<b>Datasheet Identification</b>	Product Status	Definition	
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.	
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.	
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.	
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.	

Rev. 166

<sup>\*</sup> Trademarks of System General Corporation, used under license by Fairchild Semiconductor.